# 74CBTLV3126-Q100

### 4-bit bus switch

Rev. 4 — 23 March 2020

Product data sheet

### 1. General description

The 74CBTLV3126-Q100 provides a 4-bit high-speed bus switch with separate output enable inputs (1OE to 4OE). The low on-state resistance of the switch allows connections to be made with minimal propagation delay. The switch is disabled (high-impedance OFF-state) when the output enable (nOE) input is LOW.

To ensure the high-impedance OFF-state during power-up or power-down, nOE should be tied to the GND through a pull-down resistor. The current-sinking capability of the driver determines the minimum value of the resistor.

Schmitt trigger action at control input makes the circuit tolerant to slower input rise and fall times across the entire  $V_{CC}$  range from 2.3 V to 3.6 V.

This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Supply voltage range from 2.3 V to 3.6 V
- Standard '126'-type pinout
- High noise immunity
- Complies with JEDEC standard:
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8-B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- 5 Ω switch connection between two ports
- Rail to rail switching on data I/O ports
- CMOS low power consumption
- Latch-up performance exceeds 250 mA per JESD78B Class I level A
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

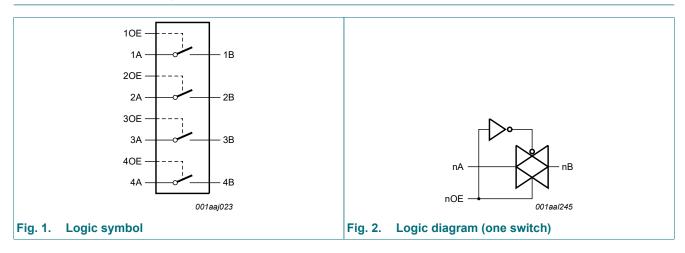


# 3. Ordering information

#### **Table 1. Ordering information**

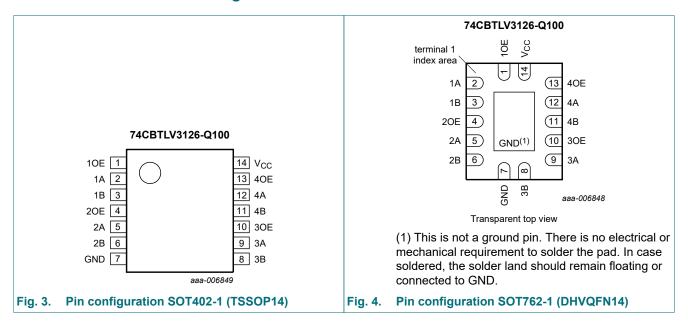
Type number	Package			
	Temperature range	Name	Description	Version
74CBTLV3126PW-Q100	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74CBTLV3126BQ-Q100	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm	SOT762-1

# 4. Functional diagram



### 5. Pinning information

### 5.1. Pinning



### 5.2. Pin description

Table 2. Pin description

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Symbol	Pin	Description
10E, 20E, 30E, 40E	1, 4, 10, 13	output enable input
1A, 2A, 3A, 4A	2, 5, 9, 12	A input/output
1B, 2B, 3B, 4B	3, 6, 8, 11	B output/input
GND	7	ground (0 V)
V <sub>CC</sub>	14	supply voltage

### 6. Functional description

#### **Table 3. Function table**

H = HIGH voltage level; L = LOW voltage level.

Output enable input nOE	Function switch
L	OFF-state
Н	ON-state

### 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+4.6	V
VI	input voltage	control inputs	[1]	-0.5	+4.6	V
V <sub>SW</sub>	switch voltage	enable and disable mode	[2]	-0.5	V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < -0.5 V		-50	-	mA
I <sub>SK</sub>	switch clamping current	V <sub>I</sub> < -0.5 V		-50	-	mA
I <sub>SW</sub>	switch current	$V_{SW} = 0 \text{ V to } V_{CC}$		-	±128	mA
I <sub>CC</sub>	supply current			-	+100	mA
I <sub>GND</sub>	ground current			-100	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[3]	-	500	mW

<sup>[1]</sup> The minimum input voltage rating may be exceeded if the input clamping current ratings are observed.

### 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		2.3	3.6	V
VI	input voltage	control inputs	0	3.6	V
V <sub>SW</sub>	switch voltage	enable and disable mode	0	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
Δt/ΔV	input transition rise and fall rate	pin nOE; V <sub>CC</sub> = 2.3 V to 3.6 V	0	200	ns/V

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<sup>[2]</sup> The switch voltage ratings may be exceeded if switch clamping current ratings are observed

<sup>[3]</sup> For SOT402-1 (TSSOP14) package: P<sub>tot</sub> derates linearly with 7.3 mW/K above 81 °C. For SOT762-1 (DHVQFN14) package: P<sub>tot</sub> derates linearly with 9.6 mW/K above 98 °C.

### 9. Static characteristics

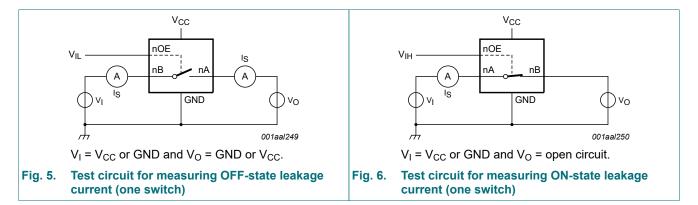
#### **Table 6. Static characteristics**

At recommended operating conditions voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T <sub>amb</sub> :	= -40 °C to ·	+85 °C	T <sub>ar</sub> -40 °C to	<sub>nb</sub> = o +125 °C	Unit
			Min	Typ [1]	Max	Min	Max	
V <sub>IH</sub>	HIGH-level input	V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
	voltage	V <sub>CC</sub> = 3.0 V to 3.6 V	2.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW-level input V <sub>CC</sub> = 2.3 V to 2.7 V		-	-	0.7	-	0.7	V
	voltage	V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	0.9	-	0.9	V
l <sub>l</sub>	input leakage current	pin nOE; $V_I$ = GND to $V_{CC}$ ; $V_{CC}$ = 3.6 V	-	-	±1.0	-	±20	μΑ
I <sub>S(OFF)</sub>	OFF-state leakage current	V <sub>CC</sub> = 3.6 V; see <u>Fig. 5</u>	-	-	±1	-	±20	μΑ
I <sub>S(ON)</sub>	ON-state leakage current	V <sub>CC</sub> = 3.6 V; see <u>Fig. 6</u>	-	-	±1	-	±20	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±10	-	±50	μΑ
I <sub>CC</sub>	supply current	$V_I$ = GND or $V_{CC}$ ; $I_O$ = 0 A; $V_{SW}$ = GND or $V_{CC}$ ; $V_{CC}$ = 3.6 V	-	-	10	-	50	μA
ΔI <sub>CC</sub>	additional supply current	pin nOE; $V_1 = V_{CC} - 0.6 \text{ V}$ ; [2] $V_{SW} = \text{GND or } V_{CC}$ ; $V_{CC} = 3.6 \text{ V}$	-	-	300	-	2000	μA
Cı	input capacitance	pin nOE; V <sub>CC</sub> = 3.3 V; V <sub>I</sub> = 0 V to 3.3 V	-	0.9	-	-	-	pF
C <sub>S(OFF)</sub>	OFF-state capacitance	V <sub>CC</sub> = 3.3 V; V <sub>I</sub> = 0 V to 3.3 V	-	5.2	-	-	-	pF
C <sub>S(ON)</sub>	ON-state capacitance	$V_{CC} = 3.3 \text{ V}; V_I = 0 \text{ V to } 3.3 \text{ V}$	-	14.3	-	-	-	pF

All typical values are measured at  $T_{amb}$  = 25 °C. One input at 3 V, other inputs at  $V_{CC}$  or GND.

#### 9.1. Test circuits



#### 9.2. ON resistance

Table 7. Resistance Ron

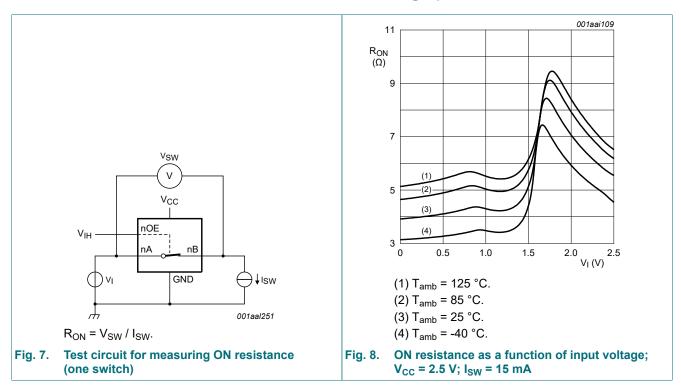
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 7.

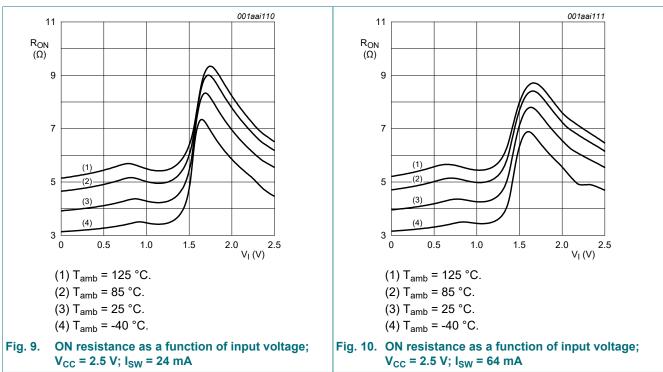
Symbol	Parameter	Conditions	T <sub>amb</sub> =	-40 °C to	+85 °C	T <sub>an</sub> -40 °C to	Unit	
			Min	Typ [1]	Max	Min	Max	
R <sub>ON</sub>	ON resistance	V <sub>CC</sub> = 2.3 V to 2.7 V; [2] see <u>Fig. 8</u> to <u>Fig. 10</u>						
		I <sub>SW</sub> = 64 mA; V <sub>I</sub> = 0 V	-	4.2	8.0	-	15.0	Ω
		I <sub>SW</sub> = 24 mA; V <sub>I</sub> = 0 V	-	4.2	8.0	-	15.0	Ω
		I <sub>SW</sub> = 15 mA; V <sub>I</sub> = 1.7 V	-	8.4	40.0	-	60.0	Ω
		V <sub>CC</sub> = 3.0 V to 3.6 V; see <u>Fig. 11</u> to <u>Fig. 13</u>						
		I <sub>SW</sub> = 64 mA; V <sub>I</sub> = 0 V	-	4.0	7.0	-	11.0	Ω
		I <sub>SW</sub> = 24 mA; V <sub>I</sub> = 0 V	-	4.0	7.0	-	11.0	Ω
		I <sub>SW</sub> = 15 mA; V <sub>I</sub> = 2.4 V	-	6.2	15.0	-	25.5	Ω

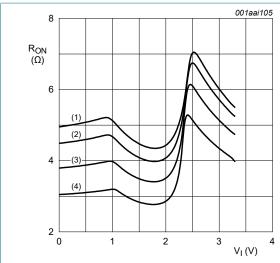
<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C and nominal  $V_{CC}$ .

<sup>[2]</sup> Measured by the voltage drop between the A and B terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

### 9.3. ON resistance test circuit and graphs

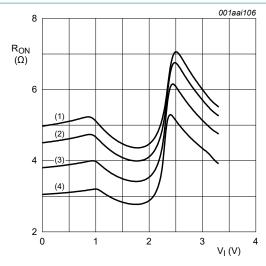






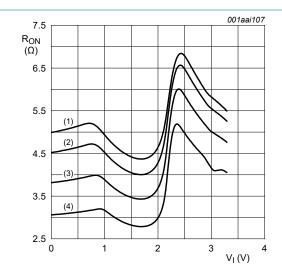
- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb}$  = 25 °C.
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig. 11. ON resistance as a function of input voltage;  $V_{CC} = 3.3 \text{ V}$ ;  $I_{SW} = 15 \text{ mA}$ 



- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40$  °C.

Fig. 12. ON resistance as a function of input voltage;  $V_{CC}$  = 3.3 V;  $I_{SW}$  = 24 mA



- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb}$  = 85 °C.
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig. 13. ON resistance as a function of input voltage;  $V_{CC}$  = 3.3 V;  $I_{SW}$  = 64 mA

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### 10. Dynamic characteristics

#### **Table 8. Dynamic characteristics**

GND = 0 V; for test circuit see Fig. 17

Symbol	Parameter	Conditions	T <sub>amb</sub> =	= -40 °C to	+85 °C		<sub>nb</sub> = 0 +125 °C	Unit
			Min	Typ [1]	Max	Min	Max	
t <sub>pd</sub>	propagation	nA to nB or nB to nA; see Fig. 15 [2][3]						
	delay	V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.13	-	0.20	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	0.20	-	0.31	ns
t <sub>en</sub>	enable time	nOE to nA or nB; see Fig. 16 [4]						
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	2.5	4.5	1.0	6.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.2	4.2	1.0	6.0	ns
t <sub>dis</sub>	disable time	nOE to nA or nB; see Fig. 16 [5]						
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	2.6	4.7	1.0	6.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	3.4	4.8	1.0	6.5	ns

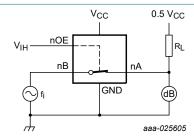
- [1] All typical values are measured at  $T_{amb}$  = 25 °C and at nominal  $V_{CC}$ .
- The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the load capacitance, when driven by an ideal voltage source (zero output impedance).
- [3]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [4] t<sub>en</sub> is the same as t<sub>PZH</sub> and t<sub>PZL</sub>.
- [5] t<sub>dis</sub> is the same as t<sub>PHZ</sub> and t<sub>PLZ</sub>.

### 10.1. Additional dynamic characteristics

#### Table 9. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V);

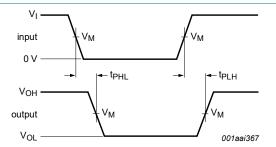
Symbol	Parameter	Conditions	T,	<sub>amb</sub> = 25 °	С	Unit
			Min	Тур	Max	
f <sub>(-3dB)</sub>		$V_I$ = GND or $V_{CC}$ ; $t_r$ = $t_f$ ≤ 2.5 ns; $V_{CC}$ = 3.3 V; $R_L$ = 50 $\Omega$ ; see Fig. 14	-	406	-	MHz



nOE connected to  $V_{CC}$ ;  $f_i$  is biased at  $0.5V_{CC}$ . Adjust  $f_i$  voltage to obtain 0 dBm level at output. Increase  $f_i$  frequency until dB meter reads -3 dB.

Fig. 14. Test circuit for measuring the frequency response when channel is in ON-state

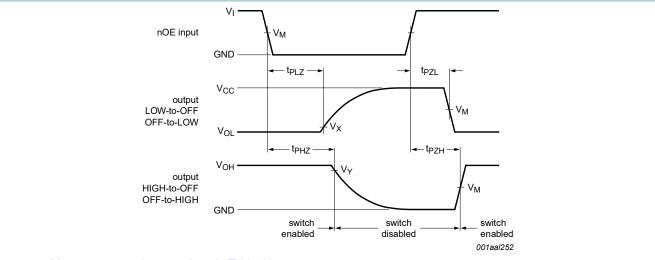
#### 10.2. Waveforms and test circuit



Measurement points are given in Table 10.

Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig. 15. The data input (nA or nB) to output (nB or nA) propagation delays



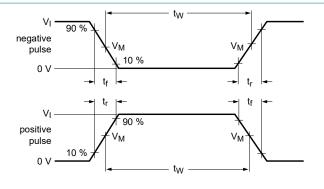
Measurement points are given in Table 10.

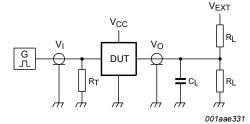
Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig. 16. Enable and disable times

**Table 10. Measurement points** 

Supply voltage	Input		Output					
V <sub>CC</sub>	V <sub>M</sub>		V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>			
2.3 V to 2.7 V	0.5V <sub>CC</sub>	V <sub>CC</sub>	0.5V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V			
3.0 V to 3.6 V	0.5V <sub>CC</sub>	V <sub>CC</sub>	0.5V <sub>CC</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V			





Test data is given in Table 11.

Definitions for test circuit:

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_0$  of the pulse generator.

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

Fig. 17. Test circuit for measuring switching times

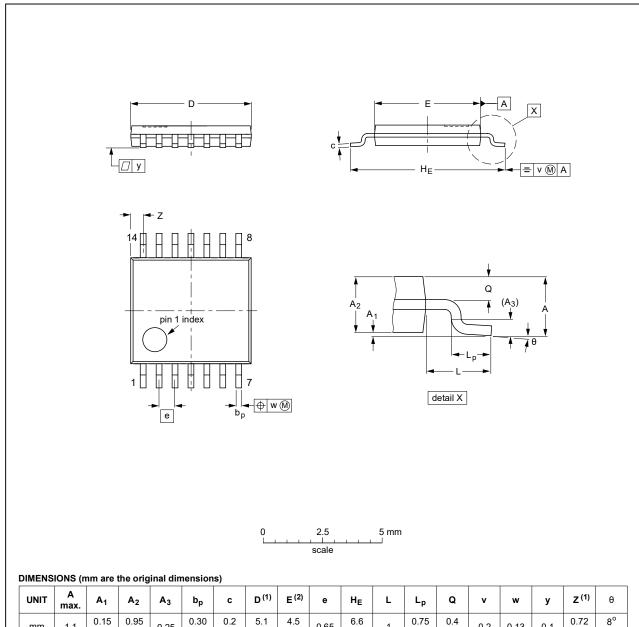
Table 11. Test data

Supply voltage	Load			V <sub>EXT</sub>					
V <sub>CC</sub>	CL	R <sub>L</sub>	$t_r = t_f$	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>			
2.3 V to 2.7 V	30 pF	500 Ω	≤ 2.0 ns	open	GND	2V <sub>CC</sub>			
3.0 V to 3.6 V	50 pF	500 Ω	≤ 2.0 ns	open	GND	2V <sub>CC</sub>			

## 11. Package outline

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



UNIT	A max.	<b>A</b> <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E (2)	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES			EUROPEAN	ISSUE DATE		
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT402-1		MO-153				<del>99-12-27</del> 03-02-18	

Fig. 18. Package outline SOT402-1 (TSSOP14)

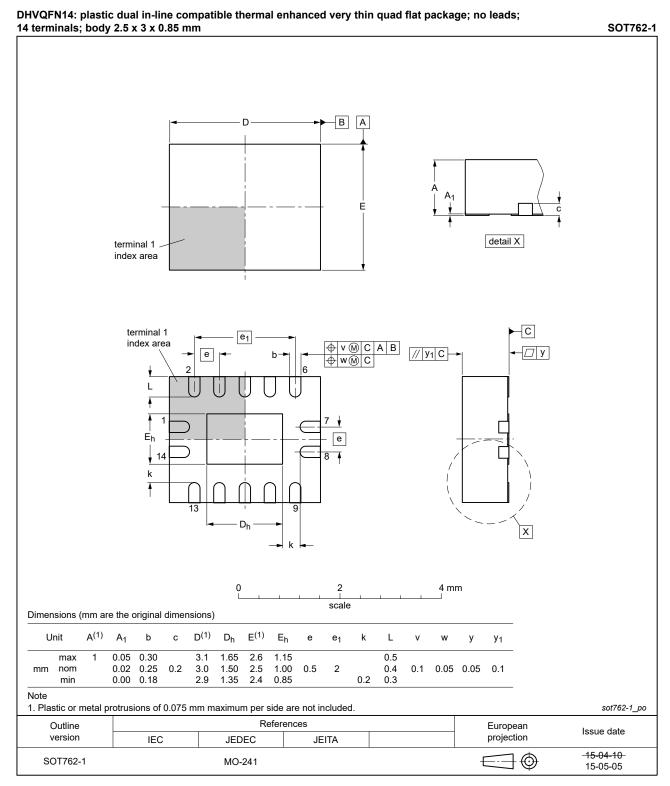


Fig. 19. Package outline SOT762-1 (DHVQFN14)

### 12. Abbreviations

#### **Table 12. Abbreviations**

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MIL	Military
MM	Machine Model

# 13. Revision history

#### **Table 13. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74CBTLV3126_Q100 v.4	20200323	Product data sheet	-	74CBTLV3126_Q100 v.3	
Modifications:	<ul> <li>Section 2 updated.</li> <li>Table 4: Derating values for P<sub>tot</sub> total power dissipation updated.</li> </ul>				
74CBTLV3126_Q100 v.3	20181009	Product data sheet	-	74CBTLV3126_Q100 v.2	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
74CBTLV3126_Q100 v.2	20161109	Product data sheet	-	74CBTLV3126_Q100 v.1	
Modifications:	• <u>Section 10.1</u>	Section 10.1 added.			
74CBTLV3126_Q100 v.1	20130403	Product data sheet	-	-	

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### 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <a href="https://www.nexperia.com">https://www.nexperia.com</a>.

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